



# Dual, Variable Gain Amplifier with Input Buffer

## FEATURES

- GAIN RANGE: 50dB
- LOW CROSSTALK: -60dB at Max Gain, f<sub>IN</sub> = 5MHz
- HIGH-SPEED VARIABLE GAIN ADJUST
- POWER SHUTDOWN MODE
- HIGH IMPEDANCE INPUT BUFFER

## **APPLICATIONS**

- ULTRASOUND SYSTEMS
- WIRELESS RECEIVERS
- TEST EQUIPMENT
- RADAR

## DESCRIPTION

The VCA2619 is a highly integrated, dual receive channel, Variable Gain Amplifier (VGA) with analog gain control.

The VCA2619s VGA section consists of two parts: the Voltage Controlled Attenuator (VCA) and the Programmable Gain Amplifier (PGA). The gain and gain range of the PGA can be digitally programmed. The combination of these two programmable elements results in a variable gain ranging from 0dB up to a maximum gain as defined by the user through external connections. The single–ended unity gain input buffer provides predictable high input impedance. The output of the VGA can be used in either a single–ended or differential mode to drive high–performance Analog–to–Digital (A/D) converters. A separate power–down pin reduces power consumption.

The VCA2619 also features low crosstalk and outstanding distortion performance. The combination of low noise and gain range programmability make the VCA2619 a versatile building block in a number of applications where noise performance is critical. The VCA2619 is available in a TQFP–32 package.



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## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Power Supply (+VS)	+6V
Analog Input	-0.3V to (+V <sub>S</sub> + 0.3V)
Logic Input	-0.3V to (+V <sub>S</sub> + 0.3V)
Case Temperature	+100°C
Junction Temperature	+150°C
Storage Temperature	−40°C to +150°C

(1) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all

integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE-LEAD	PACKAGE DESIGNATOR(1)	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA, QUANTITY
VCA2619Y	TQFP-32	PBS	-40°C to +85°C	VCA2619Y	VCA2619YT	Tape and Reel, 250
VCA20191	1057-32		-40°C 10 +65°C	VCA26191	VCA2619YR	Tape and Reel, 2000

(1) For the most current specification and package information, refer to our web site at www.ti.com.



## ELECTRICAL CHARACTERISTICS

At  $T_A = +25^{\circ}$ C,  $V_{DD} = 5$ V, load resistance = 500 $\Omega$  on each output to ground single–ended output (1Vpp), MGS = 111, VCA<sub>CNTL</sub> = 2.9V and f<sub>IN</sub> = 5MHz, unless otherwise noted.

			VCA2619			
PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNIT	
BUFFER						
Input Resistance			600		kΩ	
Input Capacitance			5		pF	
Input Bias Current			1		nA	
Maximum Input Voltage			1		Vpp	
Input Voltage Noise	PGA Gain = 45dB, $R_S = 50\Omega$		5.9		nV/√Hz	
Input Current Noise	Independent of Gain		350		fA/√Hz	
Noise Figure Bandwidth	$R_F = 550\Omega$ , PGA Gain = 45dB, $R_S = 75\Omega$		13 100		dB MHz	
			100		IVITIZ	
PROGRAMMABLE VARIABLE GAIN AMPLIFIER Peak Input Voltage			1		Vpp	
-3dB Bandwidth			20		MHz	
			-			
Slew Rate	D > 5000 Each Gide to Oraurd		300 2.5 ±1		V/µs V	
Output Signal Range	$R_L \ge 500\Omega$ Each Side to Ground		-		-	
Output Impedance			1		Ω	
Output Short-Circuit Current			±40		mA	
3rd-Harmonic Distortion	$V_{OUT} = 1$ Vpp, VCA <sub>CNTL</sub> = 2.9V	-45	-60		dBc	
2nd-Harmonic Distortion	$V_{OUT} = 1Vpp, VCA_{CNTL} = 2.9V$	-42	-50		dBc	
2nd-Harmonic Distortion	Differential, V <sub>OUT</sub> = 2Vpp, VCA <sub>CNTL</sub> = 3.0V, MGS = 011		-50		dBc	
Overload Performance (2nd-Harmonic Distortion)	Input Signal = 0.5Vpp, VCA <sub>CNTL</sub> = 2V		-40 to -45		dB	
Time Delay			5		ns	
IMD, 2–Tone	$V_{OUT} = 2Vpp, f = 9.95MHz$		-59		dBc	
Crosstalk	2Vpp Differential		-60		dB	
ACCURACY						
Gain Slope	VCA <sub>CNTL</sub> = 0.4V to 2.9V		20		dB/V	
Gain Error <sup>(1)</sup>	$VCA_{CNTL} = 0.2V \text{ to } 3.0V$		±2.75		dB	
Output Offset Voltage	$VCA_{CNTL} = 0.4V$ to 2.9V		±1.50 ±50	±2.0	dB mV	
Gain Range	VCA <sub>CNTL</sub> = 0.2V to 3.0V		52		dB	
	VCA <sub>CNTL</sub> = 0.4V to 2.9V	48	50		dB	
GAIN CONTROL INTERFACE						
Input Voltage (VCA <sub>CNTL</sub> ) Range			0 to 3.0		V	
Input Resistance			1		MΩ	
Response Time	45dB Gain Change		0.2		μs	
POWER SUPPLY						
Specified Operating Range		4.75	5.0	5.25	V	
Power Dissipation			240	300	mW	
Power-Down			9.2		mW	

(1) Referenced to best fit dB-linear curve.



### PIN CONFIGURATION



### **PIN CONFIGURATION**

PIN	DESIGNATOR	DESCRIPTION	PIN	DESIGNATOR	DESCRIPTION
1	+INA	Noninverting Input Channel A	17	DNC	Do Not Connect
2	NC	No Internal Connection	18	NC	No Internal Connection
3	VDDR	Internal Reference Supply	19	NC	No Internal Connection
4	VBIAS	Bias Voltage	20	PD	Power-Down (Active LOW)
5	VCM	Common–Mode Voltage	23	MGS <sub>1</sub>	Maximum Gain Select 1 (MSB)
6	GND <sub>R</sub>	Internal Reference Ground	22	MGS <sub>2</sub>	Maximum Gain Select 2
7	NC	No Internal Connection	23	MGS <sub>3</sub>	Maximum Gain Select 3 (LSB)
8	+INB	Noninverting Input Channel B	24	VCACNTL	VCA Analog Control
9	NC	No Internal Connection	25	NOUTA	Negative VCA Output Channel A
10	NC	No Internal Connection	26	Pouta	Positive VCA Output Channel A
11	C <sub>P2B</sub>	Coupling Capacitor Channel B	27	GNDA	Ground Channel A
12	C <sub>P1B</sub>	Coupling Capacitor Channel B	28	V <sub>DDA</sub>	+5V Supply Channel A
13	VDDB	+5V Supply Channel B	29	C <sub>P1A</sub>	Coupling Capacitor Channel A
14	GNDB	Ground Channel B	30	C <sub>P2A</sub>	Coupling Capacitor Channel A
15	POUTB	Positive Output Channel B	31	NC	No Internal Connection
16	NOUTB	Negative Output Channel B	32	NC	No Internal Connection

+85°C

40°C

2.2 2.4 2.6 2.8

MGS = 010

ŕ

MGS = 111

+25

## **TYPICAL CHARACTERISTICS**

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At  $T_A = 25^{\circ}C$  and  $V_{DD} = 5V$ , load resistance = 500 $\Omega$  on each output to ground, differential output (2Vpp) MGS = 111, and  $f_{IN} = 5MHz$ , unless otherwise noted.





VCA<sub>CNTL</sub> = 2.9V

100M

1k

 $R_s = 50\Omega$ 

<del>,</del> 🖈

10M

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## **TYPICAL CHARACTERISTICS (continued)**

At  $T_A = 25^{\circ}C$  and  $V_{DD} = 5V$ , load resistance = 500 $\Omega$  on each output to ground, differential output (2V<sub>PP</sub>) MGS = 111, and  $f_{IN} = 5MHz$ , unless otherwise noted.





## **TYPICAL CHARACTERISTICS (continued)**

TRUMENTS www.ti.com

At  $T_A = 25^{\circ}C$  and  $V_{DD} = 5V$ , load resistance = 500 $\Omega$  on each output to ground, differential output (2V<sub>PP</sub>) MGS = 111, and  $f_{IN} = 5MHz$ , unless otherwise noted.





## **TYPICAL CHARACTERISTICS (continued)**

At  $T_A = 25^{\circ}C$  and  $V_{DD} = 5V$ , load resistance = 500 $\Omega$  on each output to ground, differential output (2V<sub>PP</sub>) MGS = 111, and  $f_{IN} = 5MHz$ , unless otherwise noted.





INTERMODULATION DISTORTION







## **TYPICAL CHARACTERISTICS (continued)**

At  $T_A = 25^{\circ}C$  and  $V_{DD} = 5V$ , load resistance = 500 $\Omega$  on each output to ground, differential output (2V<sub>PP</sub>) MGS = 111, and  $f_{IN} = 5MHz$ , unless otherwise noted.





## **OVERVIEW**

TRUMENTS

The VCA2619 is a dual-channel, VGA consisting of three primary blocks: an Input Buffer, a VCA, and a PGA. All stages are ac coupled, with the coupling into the PGA stage being made variable by placing an external capacitor between the CP1 and CP2 pins. This will be discussed further in the PGA section. By using the internal coupling into the PGA, the result is a high-pass filter characteristic with cutoff at approximately 75kHz. The output PGA naturally rolls off at around 30MHz, making the usable bandwidth of the VCA2619 between 75kHz and 30MHz.



Figure 1. Simplified Block Diagram of the VCA2619.

### **INPUT BUFFER**

The input buffer is a unity gain amplifier (gain of +1) with a bandwidth of 100MHz with an input resistance of approximately  $600k\Omega$ . The input buffer isolates the circuit driving the VCA2619 inputs from the internal VCA block, which would present a varying impedance to the input circuitry. To allow symmetrical operation of the input buffer, the input to the buffer must be ac coupled through an external capacitor. The recommended value of the capacitor is  $0.01\mu$ F. It should be noted that if the capacitor value were increased, the power-on time of the VCA2619 would be increased. If a decrease in the power-on time is needed, the value can be decreased to no less than 100pF.



### **VOLTAGE-CONTROLLED ATTENUATOR**

The magnitude of the VCA input signal from the input buffer is reduced by a programmable attenuation factor, set by the analog VCA Control Voltage (VCA<sub>CNTL</sub>) at pin 24. The maximum attenuation is programmable by using the three MGS bits (pins 21, 22, and 23). Figure 2 illustrates this dual-adjust characteristic.



Figure 2. Swept Attenuator Characteristic.

The MGS bits adjust the overall range of attenuation and maximum gain while the VCA<sub>CNTL</sub> voltage adjusts the actual attenuation factor. Figure 3 is a simplified version of the voltage control attenuator. Figure 4 illustrates the piecewise approximation to the logarithmic control characteristics. At any given maximum gain setting, the analog variable gain characteristic is linear in dB as a function of the control voltage, and is created as a piecewise approximation of an ideal dB-linear transfer function. The VCA control circuitry is common to both channels of the VCA2619. The range for the VCA<sub>CNTL</sub> input spans from 0V to 3V. Although overdriving the VCA<sub>CNTL</sub> input above the recommended 3V maximum will not damage the part, this condition should be avoided.



Figure 3. Simplified Attenuator Diagram.

## VCA2619



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Figure 4. Piecewise Approximation to Logarithmic Control Characteristics.

### PGA POST-AMPLIFIER

Figure 5 shows a simplified circuit diagram of the PGA block. As stated before, the input to the PGA is ac coupled with an internal capacitor. Provisions are made so that an external capacitor can be placed in parallel with the internal capacitor, thus lowering the usable low-frequency bandwidth. The low-frequency bandwidth is set by the following equation:

$$\frac{1}{(2 \cdot \pi \cdot 500 k\Omega \cdot (220 pF + C_{EXTERNAL}))}$$
(1)

where C<sub>EXTERNAL</sub> is the external capacitor value in farads.

Care should be taken to avoid using too large a value of capacitor, as this can increase the power-on delay time.

The PGA gain is programmed with the same MGS bits that control the VCA maximum attenuation factor. For VCA- $_{CNTL}$  = 3V (no attenuation), the VCA + PGA gain will be controlled by the programmed PGA gain (29dB to 43dB in approximately 3dB steps). For clarity, the gain and attenuation factors are detailed in Table I.

Table 1. MGS Settings.

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MGS SETTING	ATTENUATOR GAIN VCA <sub>CNTL</sub> = 0.2V TO 3V	ATTENUATOR + DIFFERENTIAL PGA GAIN
000	Not Valid	Not Valid
001	Not Valid	Not Valid
010	-41.0dB to 0dB	-12dB to 29dB
011	-43.3dB to 0dB	-11.5dB to 31.8dB
100	-46.4dB to 0dB	-11.5dB to 34.9dB
101	-48.2dB to 0dB	-10.6dB to 37.6dB
110	-50.2dB to 0dB	-9.8dB to 40.4dB
111	-52.3dB to 0dB	-9.3dB to 43.3dB

The PGA architecture converts the single–ended signal from the VCA into a differential signal. Low input noise was also a requirement of the PGA design due to the large amount of signal attenuation that can be asserted before the PGA. At minimum VCA attenuation (used for small input signals), the input buffer noise dominates; at maximum VCA attenuation (large input signals), the PGA noise dominates. Note that if the PGA output is single–ended, the apparent gain will be 6dB lower.



Figure 5. Simplified Block Diagram of PGA.



## LAYOUT CONSIDERATIONS

The VCA2619 is an analog amplifier capable of high gain. When working on a PCB layout for the VCA2619, it is recommended to utilize a solid ground plane that is connected to analog ground. This helps to maximize the noise performance of the VCA2619. Adequate power–supply decoupling must be used in order to achieve the best possible performance. Decoupling capacitors on the VCA<sub>CNTL</sub> voltage should also be used to help minimize noise. Recommended values can be obtained from the layout diagram of Figure 6.



Figure 6. VCA2619 Layout.

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
VCA2619YR	ACTIVE	TQFP	PBS	32	2000	None	Call TI	Call TI
VCA2619YT	ACTIVE	TQFP	PBS	32	250	None	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

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at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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## **MECHANICAL DATA**

MPQF027 - NOVEMBER 1995

### PBS (S-PQFP-G32)

PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.



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